DNSemi

Schottky Barrier Diode

NSR0170

Schottky barrier diodes are optimized for very low forward voltage drop and low leakage current making them ideal devices to be used in a wide range of dc-dc converter, clamping and protection applications. NSR0170 in SOD-323, SOD-923 and X2DFNW2 miniature packages enable designers to meet the challenging task of achieving higher efficiency while meeting reduced PCB space requirements.

Features

- Very Low Forward Voltage Drop 560 mV @ 10 mA
- Low Reverse Current 25 nA @ 50 V VR
- 70 mA of Continuous Forward Current
- Power Dissipation of 240 mW with Minimum Trace
- Very High Switching Speed
- Low Capacitance CT = 2 pF
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- NSVR0170MX2WT5G Wettable Flank Package for Optimal Automated Optical Inspection (AOI)
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost DC-DC Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

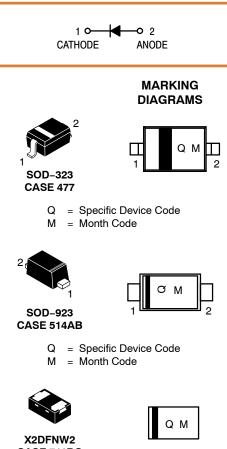
Markets

- Mobile Handsets and MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS
- Automotive ECUs

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	70	V
Forward Current (DC)	١ _F	70	mA
ESD Rating: Human Body Model Machine Model	ESD	Class 2 Class B	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



70 V SCHOTTKY BARRIER DIODE

CASE 711BG

- Q = Specific Device Code
- М = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]	
NSR0170HT1G	SOD-323 (Pb-Free)	3000/ Tape & Reel	
NSVR0170HT1G	(FD-FIGE)		
NSR0170P2T5G	SOD-923 (Pb-Free)	2 mm Pitch 8000/	
NSVR0170P2T5G	(FD-FIEE)	Tape & Reel	
NSVR0170MX2WT5G	X2DFNW2 (Pb-Free)	8000/ Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D			520 240	°C/W mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D			175 710	°C/W mW
Junction and Storage Temperature Range	T _J , T _{stg}			-55 to +150	°C

Mounted onto a 4 in square FR-4 board 10 mm sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.
 Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage $(V_R = 50 \text{ V})$ $(V_R = 70 \text{ V})$	I _R		25 -	90 3.0	nA μA
Forward Voltage $(I_F = 1.0 \text{ mA})$ $(I_F = 10 \text{ mA})$ $(I_F = 15 \text{ mA})$	V _F		0.34 0.56 0.65	0.39 0.64 0.73	V
Total Capacitance (V _R = 0 V, f = 1 MHz)	СТ		2.0		pF

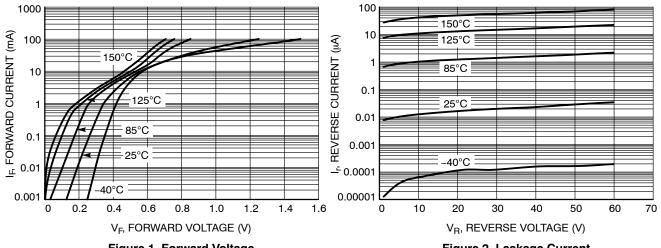
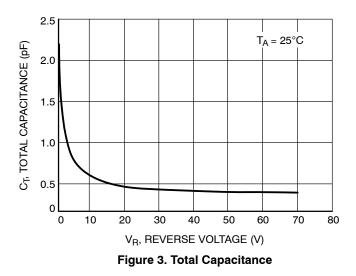




Figure 2. Leakage Current

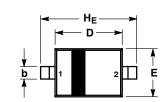


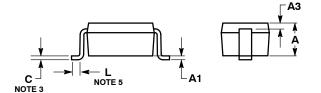
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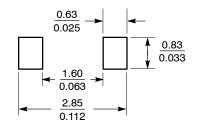








SOLDERING FOOTPRINT*



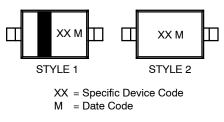
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 13 MAR 2007

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETERS.
 LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
 DIMENSION L IS MEASURED FROM END OF RADIUS.

	MILLIMETERS		INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.031	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.15 REF			0.006 REF		F
b	0.25	0.32	0.4	0.010	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.60	1.70	1.80	0.062	0.066	0.070
Е	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
HE	2.30	2.50	2.70	0.090	0.098	0.105

GENERIC **MARKING DIAGRAM***



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present.

STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE STYLE 2: NO POLARITY

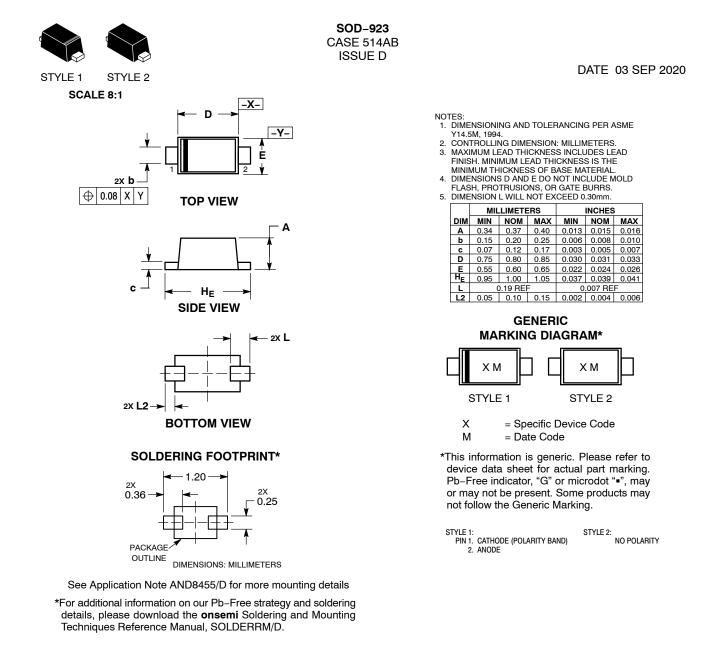
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SOD-323 CASE 477-02

ISSUE H

MECHANICAL CASE OUTLINE

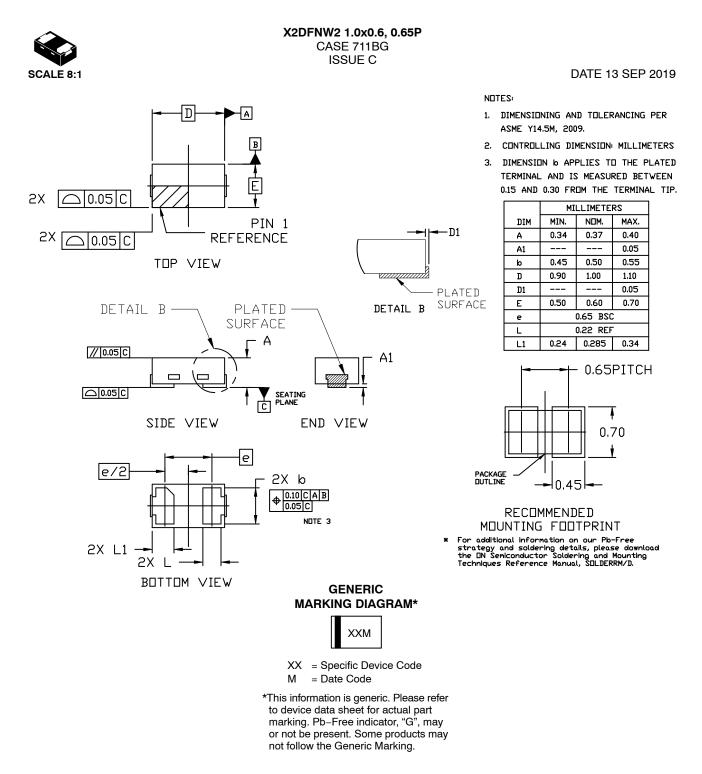
PACKAGE DIMENSIONS



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